

New Product

N-Channel 200-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}(\Omega)$ $I_{D}(A)$			
200	0.480 at V _{GS} = 10 V	1.50		
	0.510 at V _{GS} = 6.0 V	1.45		

FEATURES

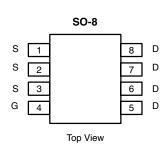
- TrenchFET® Power MOSFET
- PWM Optimized for fast Switching



RoHS

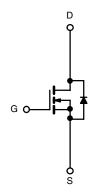
APPLICATIONS

Primary Side Switch



Ordering Information: Si4462DY-T1

Si4462DY-T1-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_A = 25$ °C, unle	ess otherwise	noted		
Parameter		Symbol	10 sec	Steady State	Unit
Drain-Source Voltage		V _{DS}	200		V
Gate-Source Voltage		V _{GS}	± 20		
Continuous Dusin Comment /T 150 °C)	T _A = 25 °C	- I _D	1.50	1.15	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		1.20	0.92	٨
Pulsed Drain Current		I _{DM}	5		Α
Single Avalanche Current	L = 0.1 mH	I _{AS}	1.5 0.11		
Single Avalanche Energy	L = 0.1 IIIH	E _{AS}			mJ
Continuous Source Current (Diode Conduction) ^a		I _S	2.1	1.1	Α
M	T _A = 25 °C	P _D	2.5	1.3	W
Maximum Power Dissipation ^a	T _A = 70 °C] ' ^D	1.6	0.85	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manipulation to Applicate	t ≤ 10 sec	R _{thJA}	40	50	°C/W
Maximum Junction-to-Ambient ^a	Steady State		70	85	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	20	24	

Notes:

a. Surface Mounted on 1" x 1" FR4 Board.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

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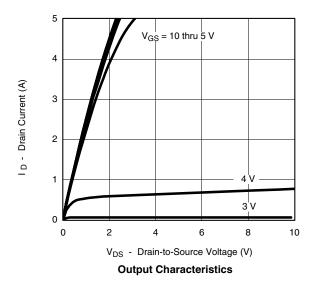
Parameter	Symbol	Symbol Test Conditions		Тур	Max	Unit
Static						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zana Oata Waltana Dunin Ouwant	I _{DSS}	V _{DS} = 200 V, V _{GS} = 0 V			1	μΑ
Zero Gate Voltage Drain Current		V _{DS} = 200 V, V _{GS} = 0 V, T _J = 55 °C			5	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	5			Α
Drain-Source On-State Resistance ^a	r	V _{GS} = 10 V, I _D = 1.5 A		0.39	0.480	
	r _{DS(on)}	V _{GS} = 6.0 V, I _D = 1.45 A		0.420	0.510	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 1.5 A		5		S
Diode Forward Voltage ^a	V_{SD}	I _S = 2.1 A, V _{GS} = 0 V		0.8	1.2	V
Dynamic ^b	1		"	•		
Total Gate Charge	Q_g			6	9	nC
Gate-Source Charge	Q _{gs} Q _{gd}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 1.5 \text{ A}$		0.9		
Gate-Drain Charge				1.9		
Gate Resistance	R_{G}			3.7		Ω
Turn-On Delay Time	t _{d(on)}			10	15	
Rise Time	t _r	t_r $V_{DD} = 100 \text{ V}, R_L = 100 \Omega$		12	20	
Turn-Off Delay Time	t _{d(off)}	$t_{d(off)}$ $I_D \cong 1.0 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 6 \Omega$		10	15	ns
Fall Time t				15	25	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.1 A, di/dt = 100 A/μs		55	90	

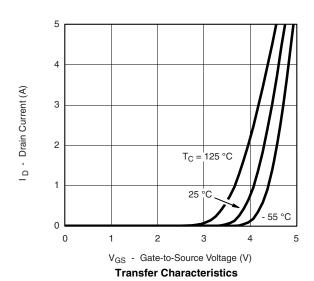
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C unless noted



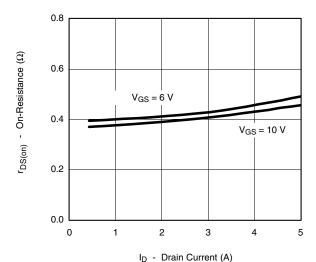




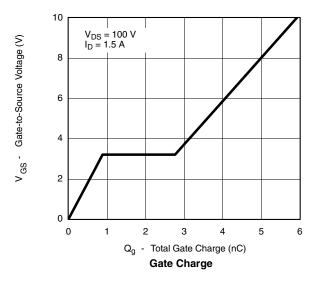


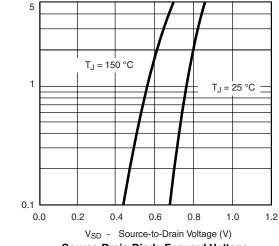


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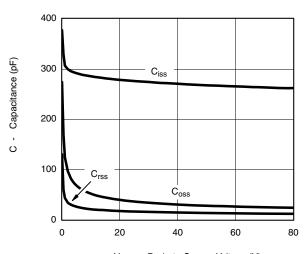


On-Resistance vs. Drain Current

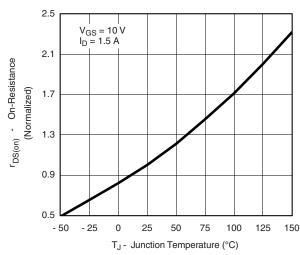




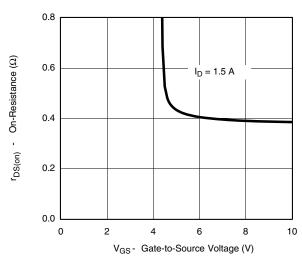
Source-Drain Diode Forward Voltage



V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



On-Resistance vs. Junction Temperature



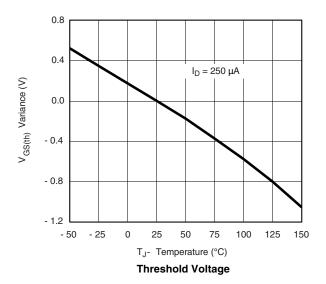
On-Resistance vs. Gate-to-Source Voltage

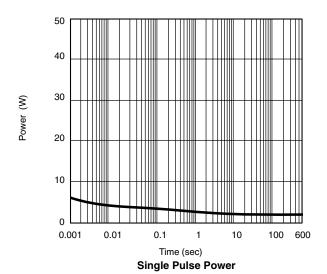
Source Current (A)

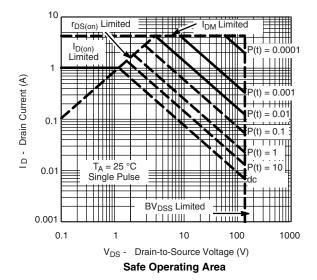
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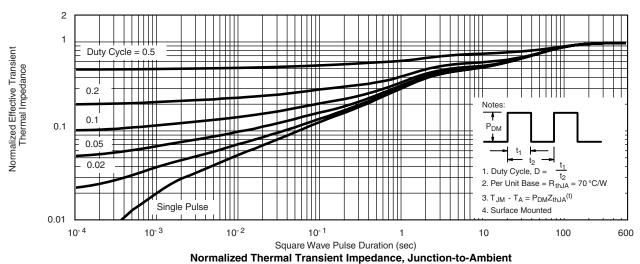
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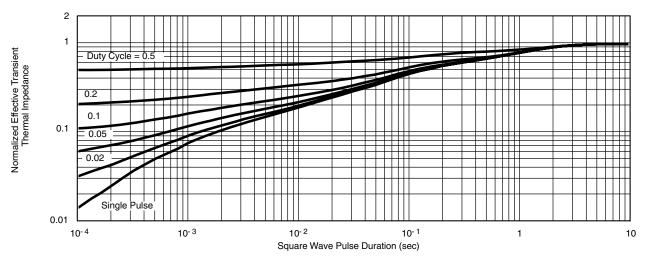








TYPICAL CHARACTERISTICS 25 °C unless noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72093.



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